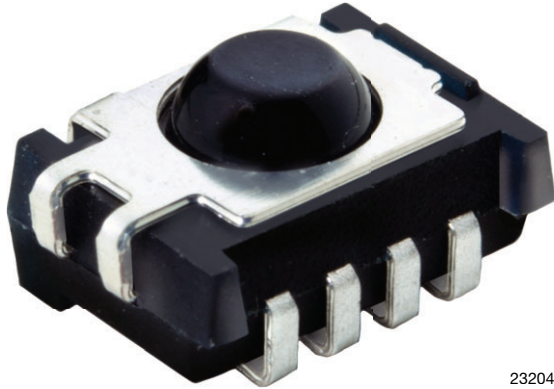




IR Mid Range Proximity Sensor



23204

DESCRIPTION

The TSSP6P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector's output pulse varies in proportion to the amount of light reflected from the object being detected.

FEATURES

- Up to 2 m for proximity sensing
- Receives 38 kHz modulated signal
- Photo detector and preamplifier in one package
- Low supply current
- Shielding against EMI
- Visible light is suppressed by IR filter
- Supply voltage: 2.0 V to 5.5 V
- Insensitive to supply voltage ripple and noise
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



LINKS TO ADDITIONAL RESOURCES



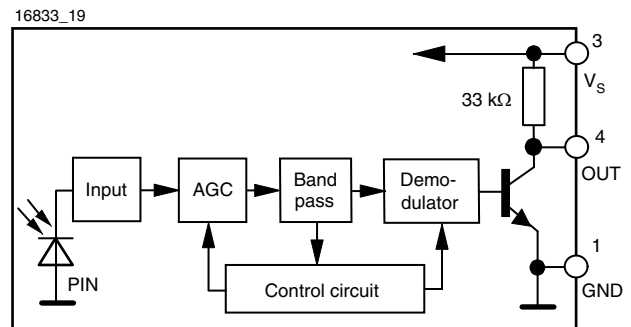
APPLICATIONS

- Object approach detection for activation of displays and user consoles, signaling of alarms, etc.
- Simple gesture controls
- Differentiation of car arrival, static, car departure in parking lots
- Reflective sensors for toilet flush
- Navigational sensor for robotics

DESIGN SUPPORT TOOLS

- [3D models](#)
- [Window size calculator](#)

BLOCK DIAGRAM

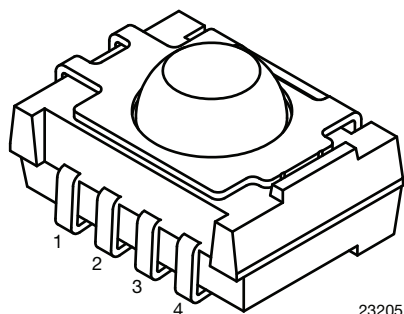




MECHANICAL DATA

Pinning

1 = GND, 2 = N.C., 3 = V_S, 4 = OUT

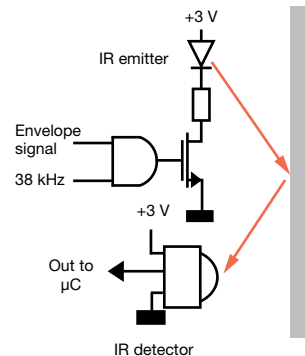


ORDERING CODE

Taping:

TSSP6P38TT - top view taped, 1190 pcs/reel
 TSSP6P38TR - side view taped, 1120 pcs/reel

PROXIMITY SENSING



PARTS TABLE	
Carrier frequency	38 kHz
Package	TSSP6P38
Pinning	Panhead
Dimensions (mm)	1 = GND, 2 = N.C., 3 = V _S , 4 = OUT
Mounting	7.5 W x 5.3 H x 4.0 D
Application	SMD
Special options	Proximity sensors
	<ul style="list-style-type: none"> Narrow optical filter: www.vishay.com/doc?81590 Wide optical filter: www.vishay.com/doc?82726

Note

- Other frequencies available by request

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage (pin 3)		V _S	-0.3 to +6	V
Supply current (pin 3)		I _S	5	mA
Output voltage (pin 4)		V _O	-0.3 to 5.5	V
Voltage at output to supply		V _S - V _O	-0.3 to (V _S + 0.3)	V
Output current (pin 4)		I _O	5	mA
Junction temperature		T _j	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

- Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability



ELECTRICAL AND OPTICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 3)	$E_e = 0, V_S = 3.3\text{ V}$	I_{SD}	0.25	0.35	0.45	mA
	$E_v = 40\text{ klx, sunlight}$	I_{SH}	-	0.45	-	mA
Supply voltage		V_S	2.0	-	5.5	V
Receiving distance	Direct line of sight, test signal see Fig. 1, IR diode TSAL6200, $I_F = 50\text{ mA}$	d	-	21	-	m
Output voltage low (pin 4)	$I_{OSL} = 0.5\text{ mA}, E_e = 0.7\text{ mW/m}^2$, test signal see Fig. 1	V_{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 5/f_0$, test signal see Fig. 1	$E_{e\text{ min.}}$	-	0.15	0.3	mW/m^2
Maximum irradiance	Pulse width tolerance: $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 5/f_0$, test signal see Fig. 1	$E_{e\text{ max.}}$	30	-	-	W/m^2
Directivity	Angle of half receiving distance	$\phi_{1/2}$	-	± 45	-	$^{\circ}$

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

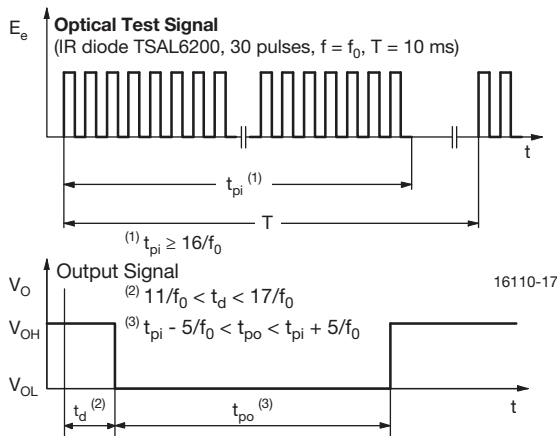


Fig. 1 - Output Active Low

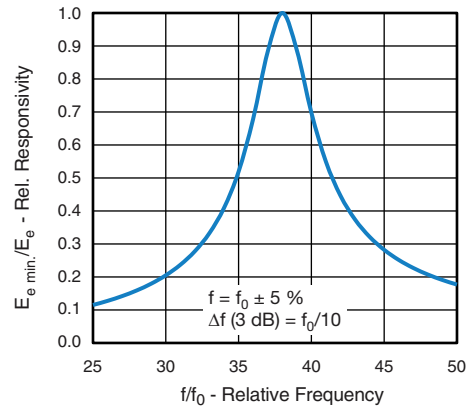


Fig. 3 - Frequency Dependence of Responsivity

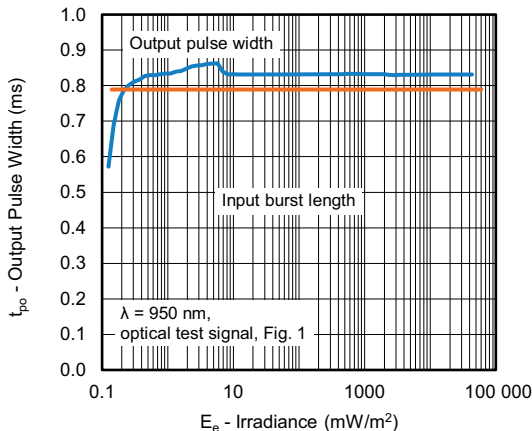


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

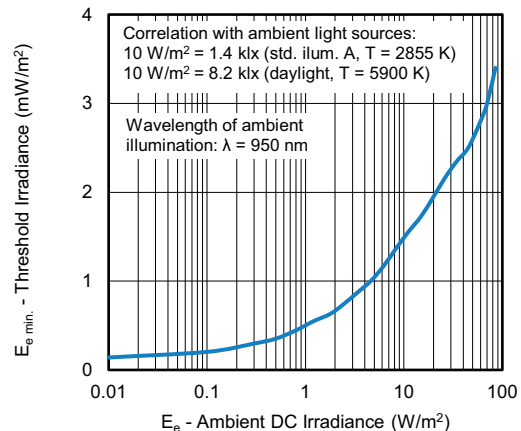


Fig. 4 - Sensitivity in Bright Ambient

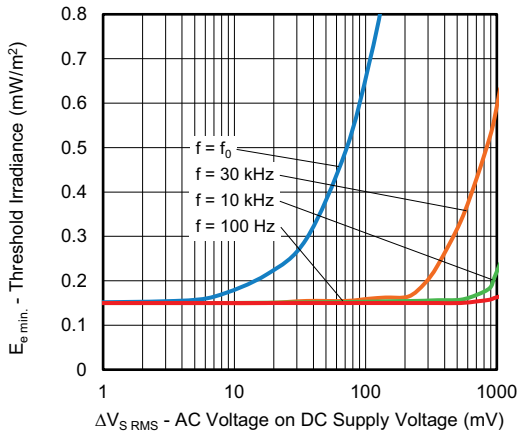


Fig. 5 - Sensitivity vs. Supply Voltage Disturbances

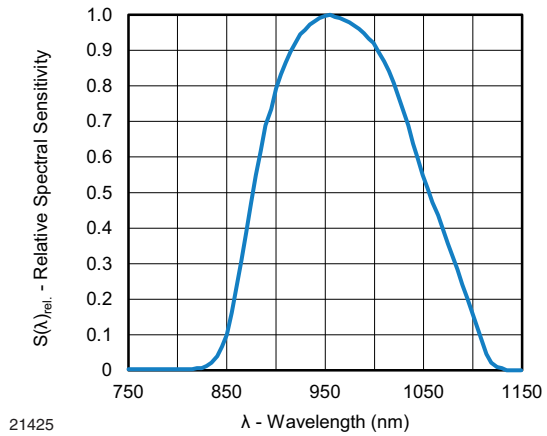


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

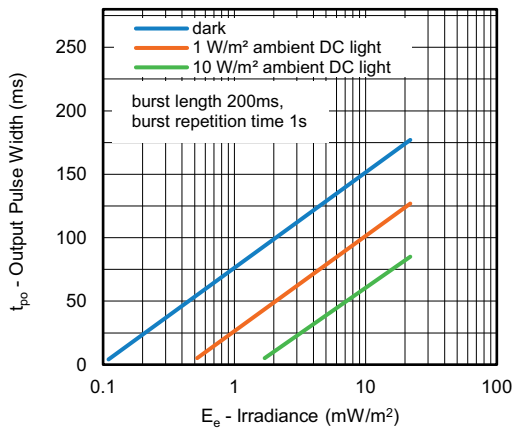


Fig. 6 - Maximum Output Pulse Width vs. Irradiance

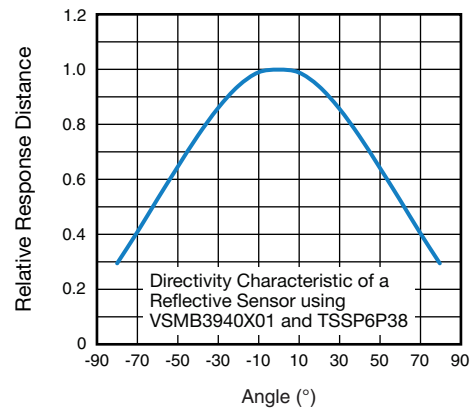


Fig. 9 - Angle Characteristic

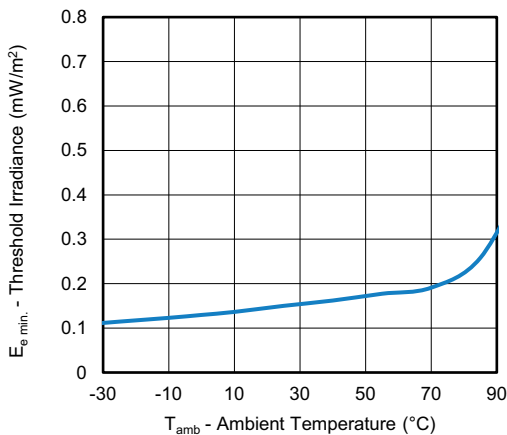


Fig. 7 - Sensitivity vs. Ambient Temperature

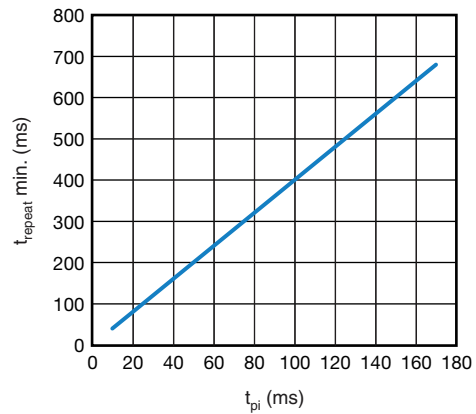


Fig. 10 - Max. Rate of Bursts

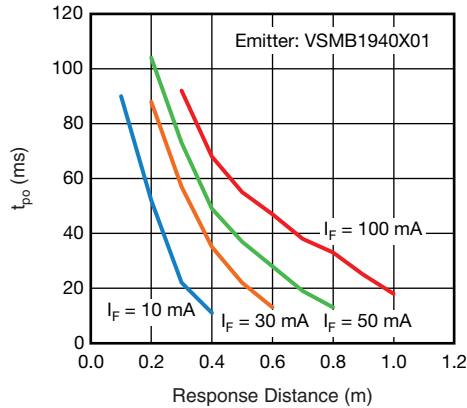


Fig. 11 - t_{po} vs. Distance Kodak Gray Card Plus 15 %

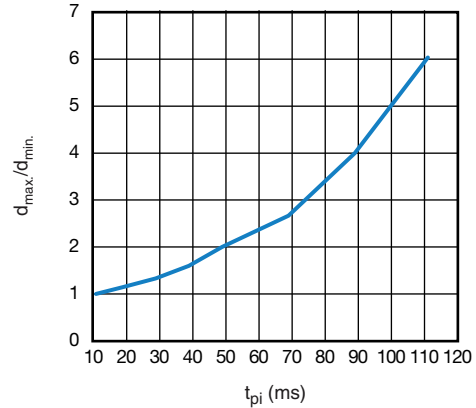
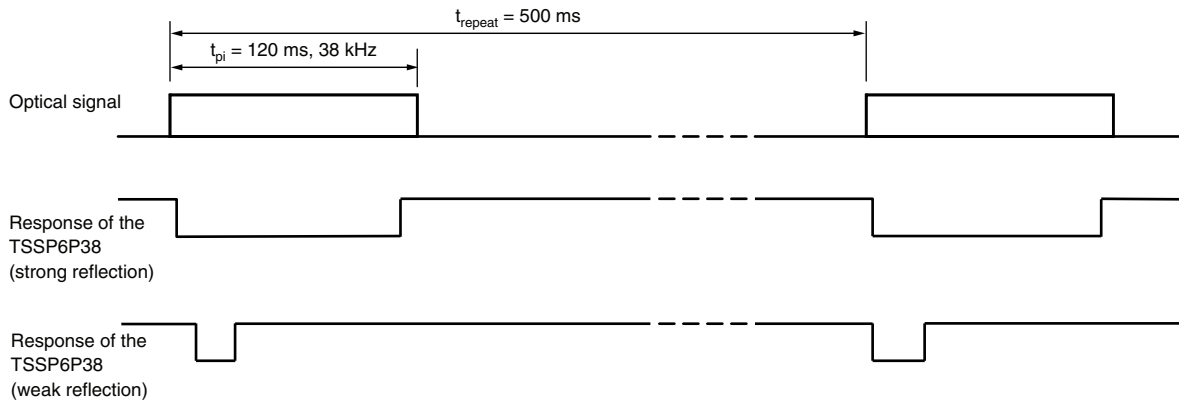


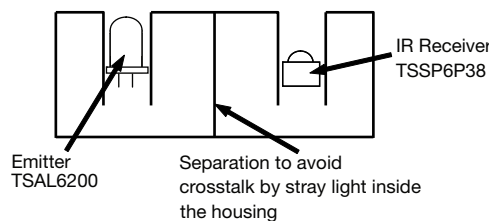
Fig. 12 - Dynamic Range of Sensor vs. t_{pi}

The typical application of the TSSP6P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

Example of a signal pattern:



Example for a sensor hardware:

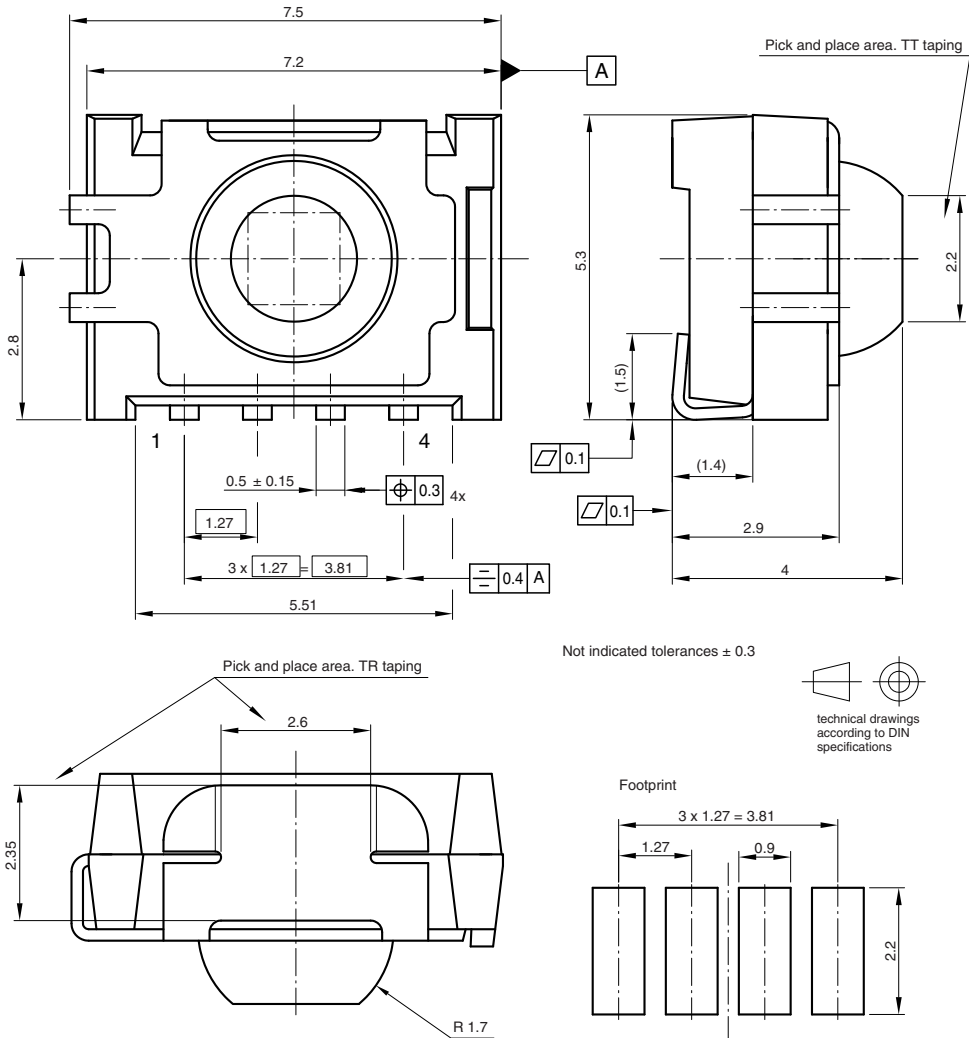


There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.

The logarithmic characteristic of the AGC in the TSSP6P38 results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.



PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5341.01-4
 Issue: 8; 02.09.09
 16776



ASSEMBLY INSTRUCTIONS

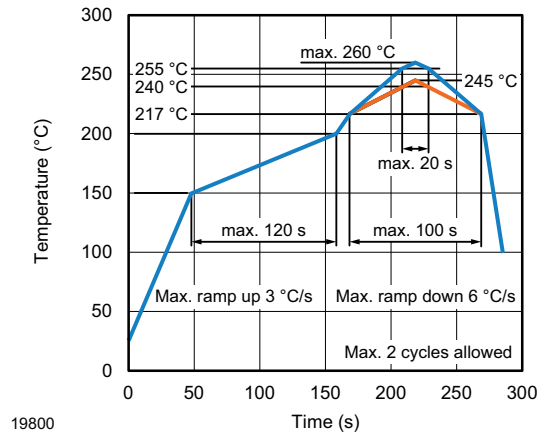
Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

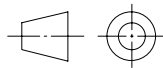
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

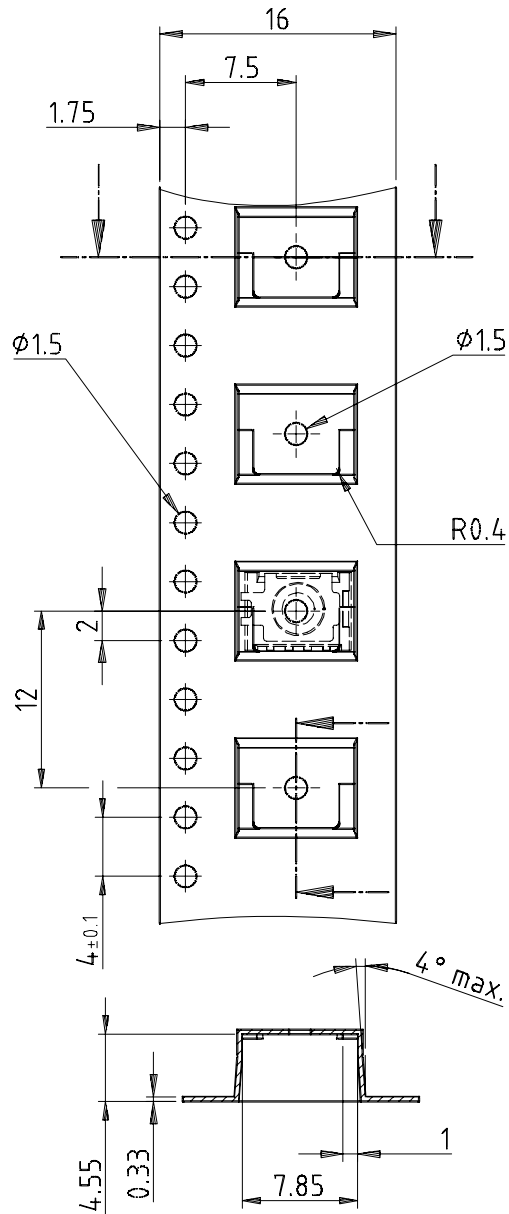
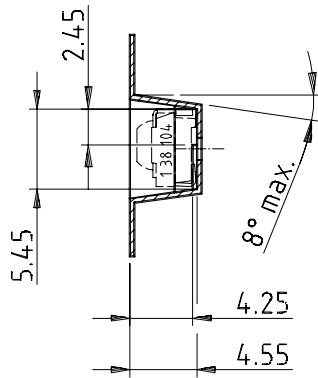




TAPING VERSION TSSP..TT DIMENSIONS in millimeters



technical drawings according to DIN specifications



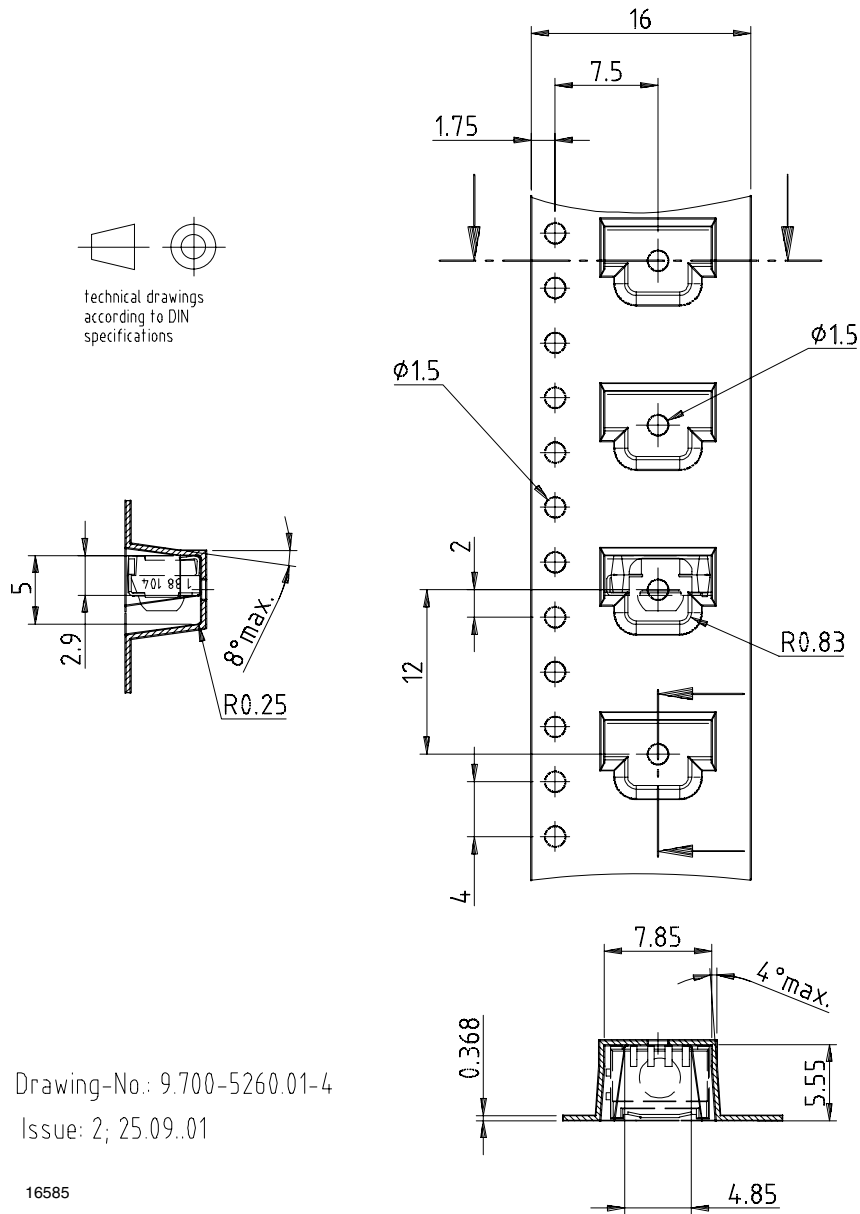
Drawing-No.: 9.700-5259.01-4

Issue: 1; 05.09.01

16584



TAPING VERSION TSSP..TR DIMENSIONS in millimeters



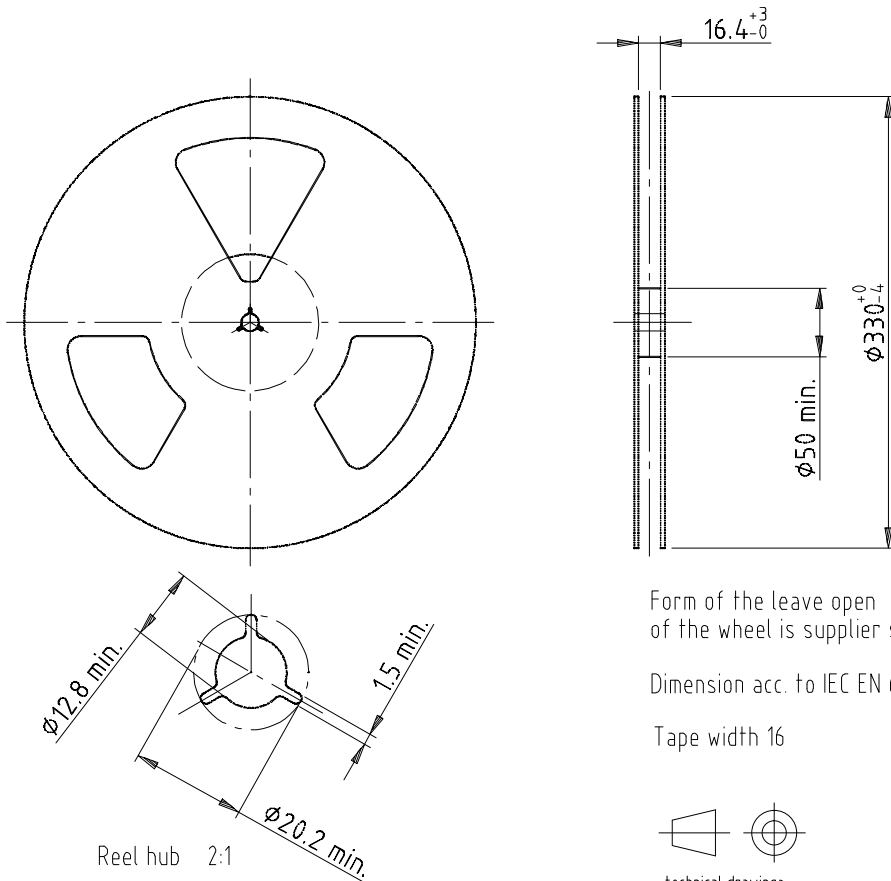
Drawing-No.: 9.700-5260.01-4

Issue: 2; 25.09..01

16585



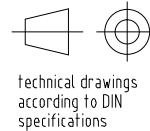
REEL DIMENSIONS in millimeters



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16

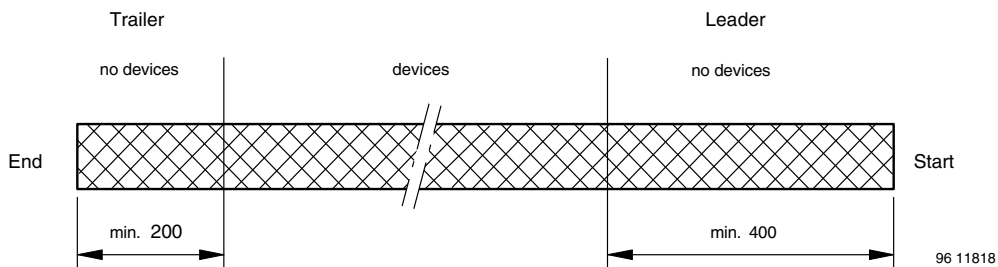


Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

LEADER AND TRAILER DIMENSIONS in millimeters





OUTER PACKAGING

The sealed reel is packed into a pizza box.

CARTON BOX DIMENSIONS in millimeters			
22127			
	THICKNESS	WIDTH	LENGTH
Pizza box (SMD and Heimdall) (taping in reels)	50	340	340

COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3
 0.1 N to 1.3 N
 300 mm/min. ± 10 mm/min.
 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

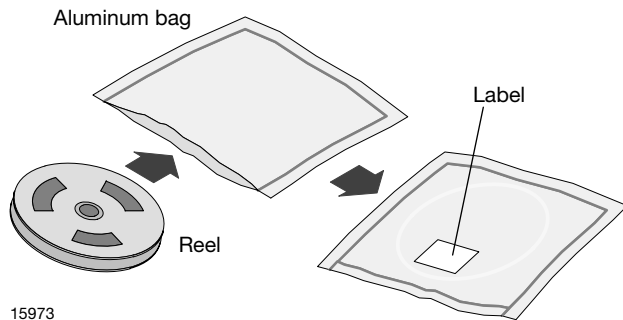
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17



DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

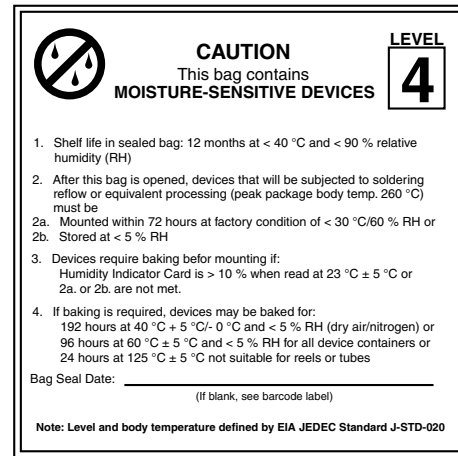
- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

- 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or
- 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
- 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



22522

EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22645



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